

Abstract Submitted
for the MAR05 Meeting of
The American Physical Society

Effect of Ionic Conductivity of Elevated Pressure TMAHCO₃/MeOH/CO₂ Mixtures on Cleaning Efficiency GALIT LEVITIN, DENNIS W. HESS, Chemical Eng., Georgia Tech — Carbon-dioxide (CO₂) based elevated pressure cleaning mixtures are being considered as environmentally benign alternatives for photoresist and plasma etch residue removal in integrated circuit and microelectronic device manufacture. Despite many attractive features, CO₂ is non-polar and has little solvating power for photoresist or inorganic materials. Therefore, addition of polar modifiers is necessary. Addition of tetramethylammonium bicarbonate (TMAHCO₃) in methanol to CO₂ at elevated pressure and temperature (3000 psi, and 70 °C) efficiently removes photoresist and post plasma etch residues. Our previous studies of the phase behavior of various cleaning mixtures have demonstrated that the cleaning phase state significantly affects cleaning effectiveness. In this work, measurements of ionic conductivity of elevated pressure cleaning solutions was studied to gain insight into the chemical-physical properties of TMAHCO₃ /methanol/CO₂ mixtures, and the resulting effect on residue removal efficiency. Ionic conductivity of cleaning mixture gives information on both the behavior of ions in the mixture and the solvation properties of the fluid medium. This work discusses the characterization of the TMAHCO₃ /methanol-modified fluids by measuring the ionic conductivity as a function of concentration and mole fraction of CO₂ at various temperatures and pressures. The ionic conductivity displays a strong dependence on the dielectric properties of the fluid medium.

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Date submitted: 29 Nov 2004

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